

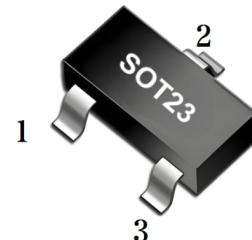


5.8A, 30V N-CHANNEL ENHANCEMENT MODE POWER MOSFET

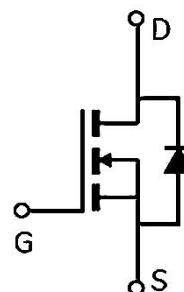
■ DESCRIPTION

The HY3404 use advanced trench technology to provide excellent RDS(ON) and low gate charge. This device is suitable for use as a load switch or in PWM applications. The source leads are separated to allow a Kelvin connection to the source, which may be used to bypass the source inductance.

The HY3404 meet the ROHS and Green Product requirement with full function reliability approved.

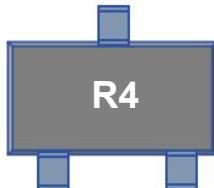


Equivalent Circuit



■ MARKING

Type Code: Marking: R4



■ ABSOLUTE MAXIMUM RATINGS(TA=25°C, unless otherwise specified.)

SYMBOL	PARAMETER	VALUE	UNIT
V _{DS}	Drain-Source Voltage	30	V
V _{GS}	Gate Source Voltage	±20	V
I _D	Continuous Drain Current (t ≤ 10s)	5.8	A
I _{DM*}	Pulsed Drain Current	30	A
P _D	Power Dissipation	0.35	W
T _J	Junction Temperature	150	°C
T _{STG}	Storage Temperature	-55~150	°C
R _{θJA}	Thermal Resistance From Junction To Ambient	357	°C/W

Notes: Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

* Repetitive rating : Pulse width limited by junction temperature.



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■ ELECTRICAL CHARACTERISTICS (TA=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
STATIC CHARACTERISTICS						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250μA	30			V
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V, V _{GS} =0V			1	μA
Gate threshold voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	1	1.4	3	V
Drain-source on-state resistance(Note 1)	R _{DS(ON)}	V _{GS} =10V, I _D =5.8A		23	30	mΩ
		V _{GS} =4.5V, I _D =4.8A		31	42	
Diode forward voltage	V _{SD}	V _{GS} =0V, I _S =1A			1	V
Forward tranconductance(Note 1)	g _{FS}	V _{DS} =5V, I _D =5.8A	5			S
DYNAMIC CHARACTERISTICS(Note 2)						
Input Capacitance	C _{ISS}	V _{GS} =0V, V _{DS} =15V, f=1MHz			820	pF
Output Capacitance	C _{OSS}			118		
Reverse Transfer Capacitance	C _{rss}			85		
SWITCHING CHARACTERISTICS(Note 2)						
Turn-On Delay Time	t _{d(on)}	V _{DS} =15V, R _L =2.6Ω, V _{GS} =10V, R _{GEN} =3Ω			6.5	ns
Turn-on rise time	t _r			3.1		
Turn-Off Delay Time	t _{d(off)}			15.1		
Turn-off fall time	t _f			2.7		

Notes: 1. Pulse Test : Pulse Width ≤ 300μs, Duty Cycle ≤ 0.5 %.

2. These parameters have no way to verify.

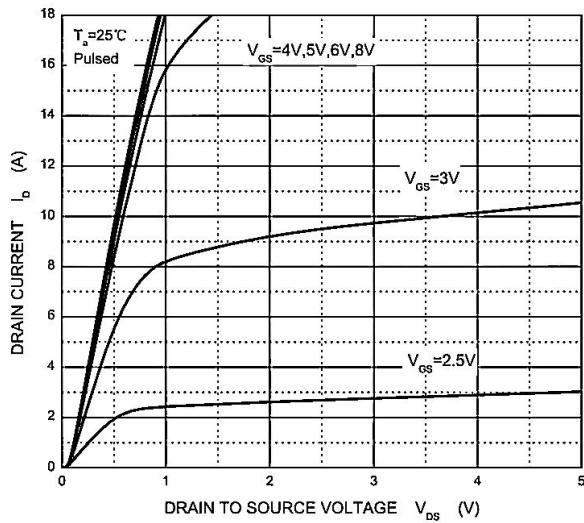


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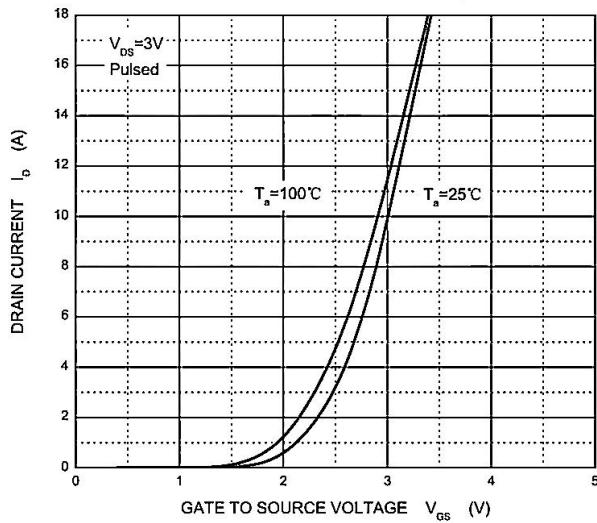
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■ TYPICAL CHARACTERISTICS

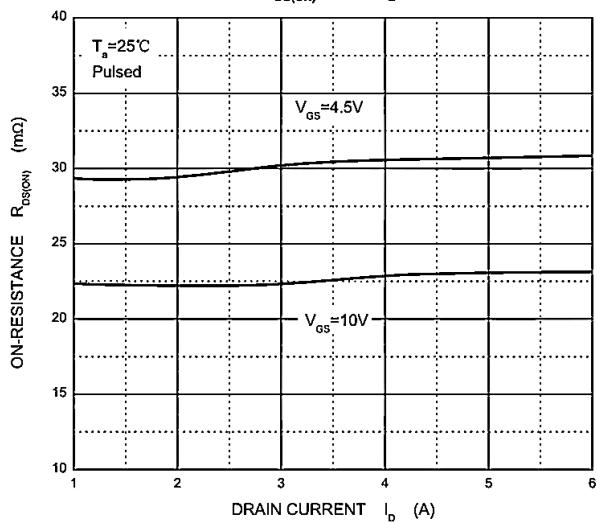
Output Characteristics



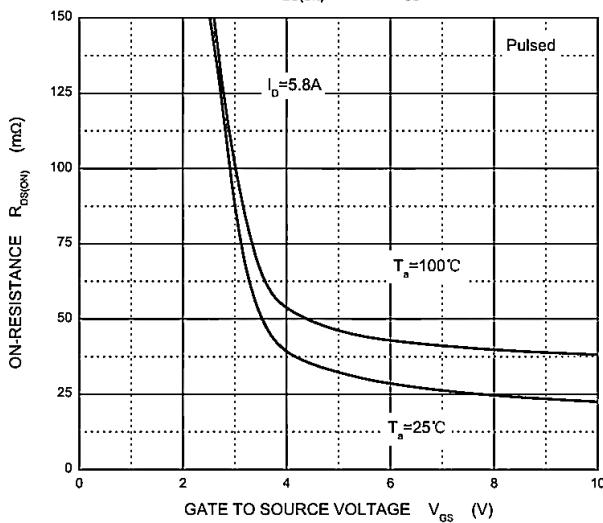
Transfer Characteristics



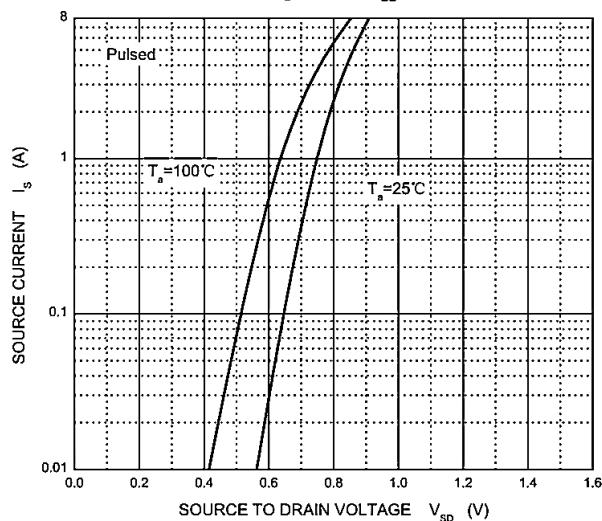
$R_{DS(ON)}$ — I_D



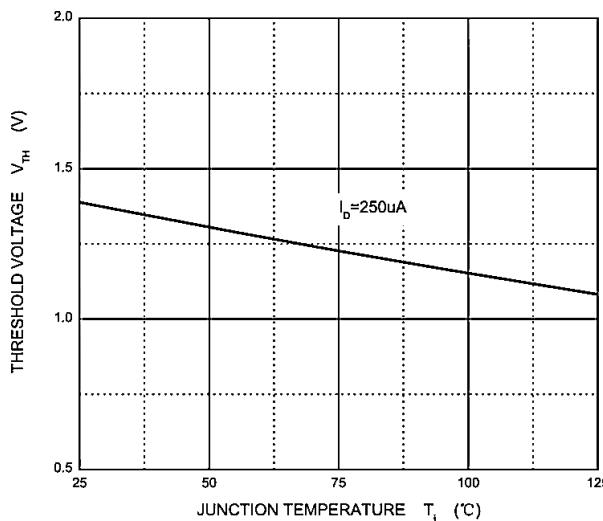
$R_{DS(ON)}$ — V_{GS}



I_S — V_{SD}



Threshold Voltage





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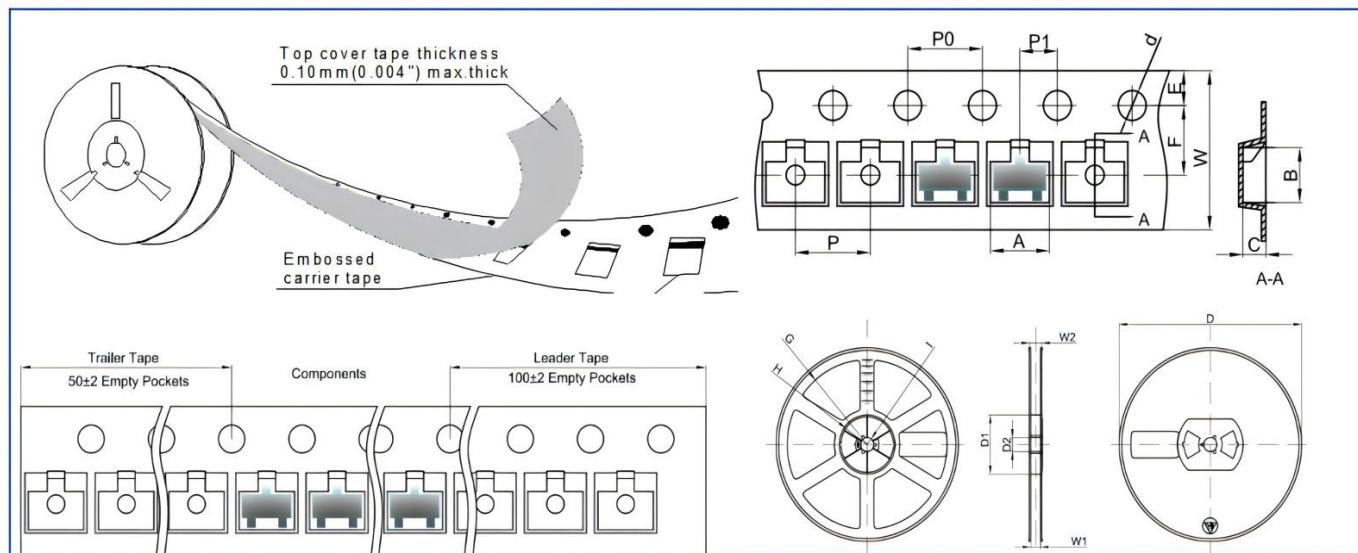
■ SOT23 PACKAGE OUTLINE DIMENSIONS

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

Note:

- Controlling dimension:in millimeters.
- General tolerance: $\pm 0.05\text{mm}$.
- The pad layout is for reference purposes only.

■ REEL PACKING



Dimensions are in millimeter										
PKG TYPE	A	B	C	d	E	F	Po	P	P1	W
SOT-23	3.15	2.77	1.22	$\Phi 1.50$	1.75	3.50	4.00	4.00	2.00	8.00
Reel Option	D	D1	D2	G	H	I	W1	W2	Q.TY PER REEL	
7" Dia	$\Phi 178.0$	54.40	13.00	R78.00	R25.60	R6.50	9.50	12.30	3000PCS	
13" Dia	$\phi 330.0$	/	13.00	/	/	R6.50	9.50	12.30	10000PCS	